

2SD1277, 2SD1277A

Silicon NPN triple diffusion planar type Darlington

For medium speed power switching

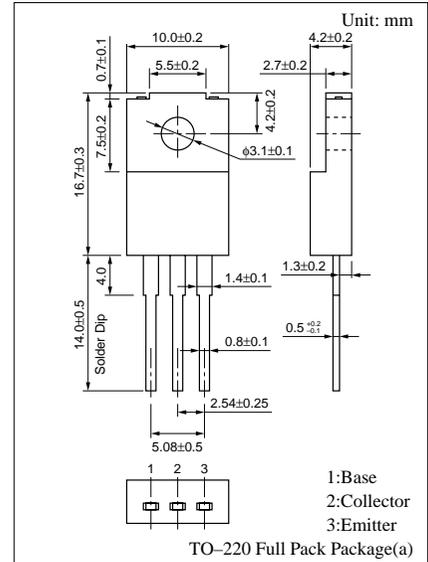
Complementary to 2SB0951 (2SB951) and 2SB0951A (2SB951A)

Features

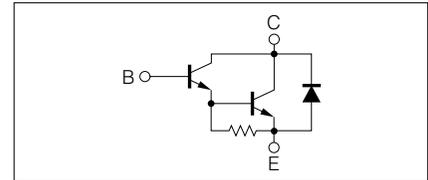
- High forward current transfer ratio h_{FE}
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$)

Parameter	Symbol	Rated	Unit
Collector to base voltage	V_{CB0}	60	V
2SD1277A		80	
Collector to emitter voltage	V_{CEO}	60	V
2SD1277A		80	
Emitter to base voltage	V_{EBO}	7	V
Peak collector current	I_{CP}	12	A
Collector current	I_C	8	A
Collector power dissipation	P_C	45	W
$T_C=25^\circ\text{C}$		2	
$T_a=25^\circ\text{C}$			
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$



Internal Connection



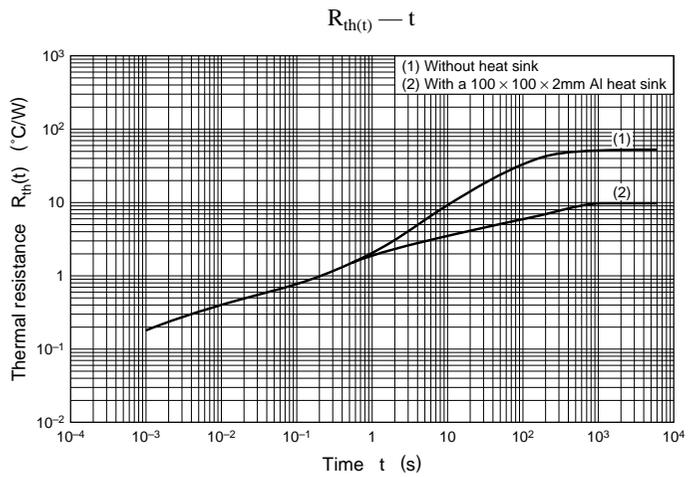
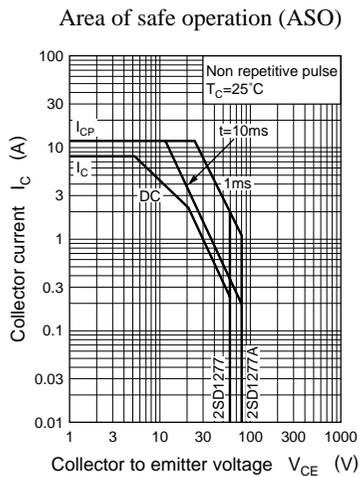
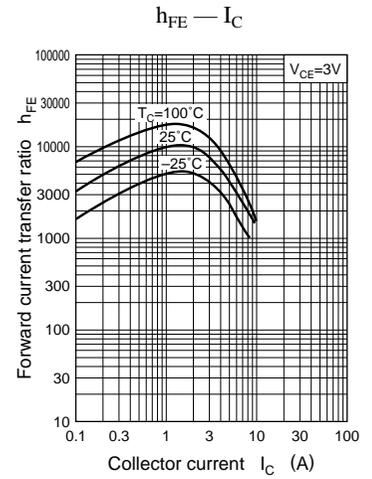
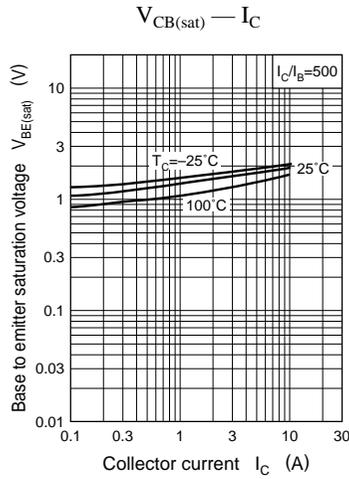
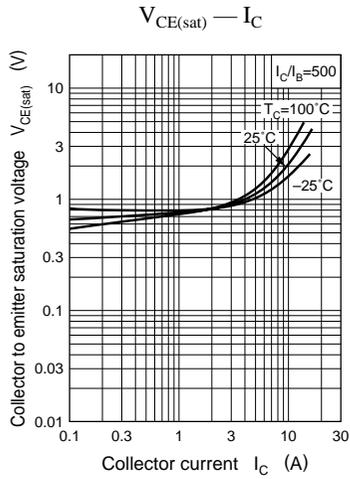
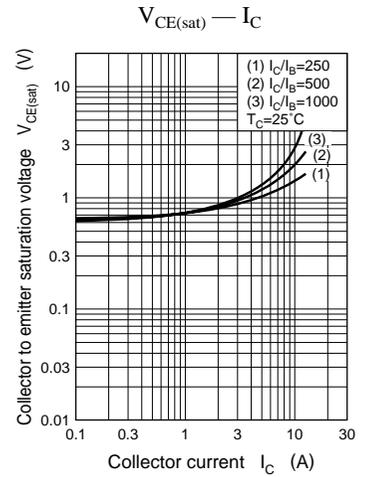
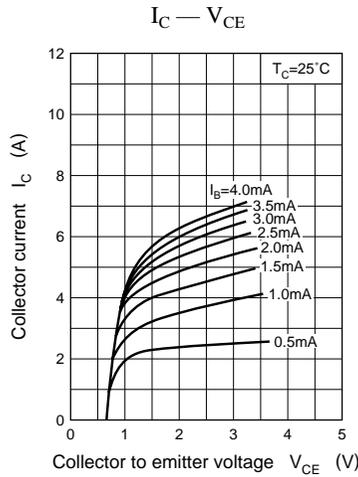
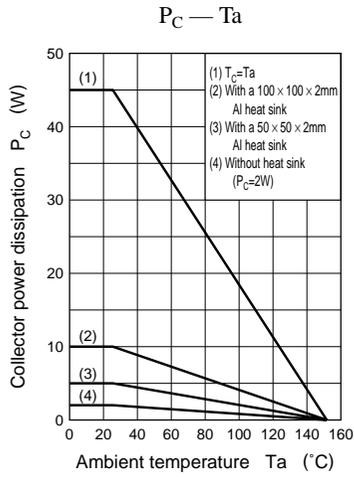
Electrical Characteristics ($T_C=25^\circ\text{C}$)

Parameter	Symbol	Conditions	min	typ	max	Unit	
Collector cutoff current	I_{CBO}	$V_{CB} = 60\text{V}, I_E = 0$			100	μA	
2SD1277A		$V_{CB} = 80\text{V}, I_E = 0$			100		
Emitter cutoff current	I_{EBO}	$V_{EB} = 7\text{V}, I_C = 0$			2	mA	
Collector to emitter voltage	V_{CEO}	$I_C = 30\text{mA}, I_B = 0$	60			V	
2SD1277A			80				
Forward current transfer ratio	h_{FE1}^*	$V_{CE} = 3\text{V}, I_C = 4\text{A}$	2000		10000		
	h_{FE2}	$V_{CE} = 3\text{V}, I_C = 8\text{A}$	500				
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 4\text{A}, I_B = 8\text{mA}$			1.5	V	
Base to emitter saturation voltage	$V_{BE(sat)}$	$I_C = 4\text{A}, I_B = 8\text{mA}$			2	V	
Transition frequency	f_T	$V_{CE} = 10\text{V}, I_C = 0.5\text{A}, f = 1\text{MHz}$	20			MHz	
Turn-on time	t_{on}	$I_C = 4\text{A}, I_{B1} = 8\text{mA}, I_{B2} = -8\text{mA}, V_{CC} = 50\text{V}$		0.5		μs	
Storage time	t_{stg}				4		μs
Fall time	t_f				1		μs

* h_{FE1} Rank classification

Rank	Q	P
h_{FE1}	2000 to 5000	4000 to 10000

Note) The part numbers in the parenthesis show conventional part number.



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